

Micropower Ultra-Sensitive Hall-Effect Switch

Features and Benefits

- Micropower operation
- Operation with either north or south pole no magnetic orientation required during assembly
- 1.65 to 3.5 V battery operation
- Chopper stabilization
 - Superior temperature stability
 - Extremely low switchpoint drift
 - Insensitive to physical stress
- Solid state reliability
- Small size: WLCSP ($\approx 1 \text{ mm} \times 1 \text{ mm} \times 0.5 \text{ mm}$)
- Complementary, push-pull outputs eliminate need for pull-up resistor

Package: 4 pin WLCSP (suffix CG)



Not to scale

Description

The A1172 is an ultra-sensitive, pole-independent Hall-effect switch with a latched digital output. It features operation at low supply currents and voltages, making it ideal for battery-operated electronics. The 1.65 to 3.5 V operating supply voltage and unique clocking algorithm reduce the average operating power requirements to less than 15 μ W with a 2.75 V supply.

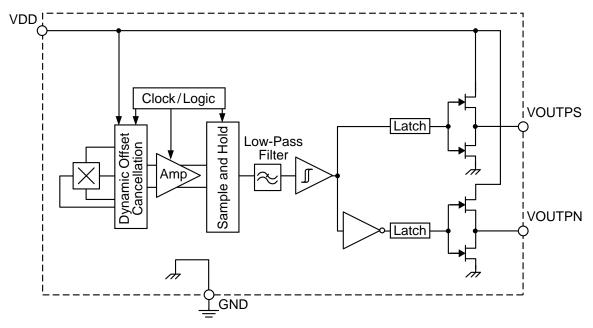
The A1172 has two push-pull output structures. Omnipolar activation for the output function is available on each output structure. As such, either a north or south pole of sufficient strength turns the available outputs off or on. The A1172 contains two complementary outputs. Therefore, for a fixed magnetic field, one output will be in a high voltage state and one output will be in a low voltage state.

Improved stability is made possible through dynamic offset cancellation using chopper stabilization, which reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress. This device

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Engineering samples available on a limited basis. Contact your local sales or applications support office for additional information.

Functional Block Diagram



A1172

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Description (continued)

includes, on a single silicon chip, a Hall-voltage generator, a small-signal amplifier, chopper stabilization, a latch, and a MOSFET output.

The A1172 device offers magnetically optimized solutions, suitable for most applications. The wafer level chip scale package (WLCSP) is approximately only 1 mm by 1 mm by 0.5 mm. This package is smaller than most plastic packages and reduces the printed circuit board area consumed by micropower Hall-effect switches.

Selection Guide

Part Numb	er	Package ¹	Pb-free	Packing*
A1172ECGL	T ²	4 bumped wafer-level chip-scale package (WLCSP)	Pb-free chip with high-temperature solder balls (RoHS compliant)	4000 pieces per reel

¹Contact Allegro[™] for additional packing options.

Absolute Maximum Ratings

Characteristic	Symbol	Notes	Rating	Units
Supply Voltage	V _{DD}		5	V
Reverse Supply Voltage	V _{RDD}		-0.3	V
Output Off Voltage	V _{OUTx}		5	V
Reverse Output Voltage	V _{ROUTx}		-0.3	V
Output Current	I _{OUTx(Sink)}		-1	mA
Output Guirent	I _{OUTx(Source)}		1	mA
Magnetic Flux Density	В		Unlimited	G
Operating Ambient Temperature	T _A	Range E	-40 to 85	°C
Maximum Junction Temperature	T _J (max)		165	°C
Storage Temperature	T _{stg}		-65 to 170	°C

Pin-out Diagram



(Bump-down view)

Terminal List Table

Name	Number	Function	
VOUTPS	A1	Push-pull output	
VOUTPN	A2	Inverted push-pull output	
GND	B1	Ground	
VDD	B2	Connects power supply to chip	



²Allegro products sold in WLCSP package types are not intended for automotive applications.

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OPERATING CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Min.	Typ. ¹	Max.	Units
Electrical Characteristics valid	over full oper	ating voltage range and T _A = 25°C		'		
Supply Voltage Range ²	V _{DD}	Operating, T _A = 25°C	1.65	-	3.5	V
Output On Voltage	V _{OUT(SAT)}	NMOS on, I _{OUT} = 1 mA, V _{DD} = 2.75 V	_	100	300	mV
Output On Voltage	V _{OUT(HIGH)}	PMOS on, I _{OUT} = 1 mA, V _{DD} = 2.75 V	V _{DD} -300	V _{DD} -100	_	mV
Period	t _{PERIOD}		_	50	100	ms
Chopping Frequency	f _C		_	200	_	kHz
Supply Slew Rate ³	SR		20	-	_	V/ms
	I _{DD(EN)}	Chip awake (enabled)	_	-	2.0	mA
Supply Current	I _{DD(DIS)}	Chip asleep (disabled)	_	-	8.0	μA
Supply Current	I _{DD(AV)}	V _{DD} = 1.80 V	_	4	8	μΑ
		V _{DD} = 3.5 V	_	6	12	μΑ
Magnetic Characteristics ⁴ at T	= 25°C and	1.8 V ≤ V _{DD} ≤ 3.5 V				
Operate Point	B _{OPS}		_	32	55	G
Operate Form	B _{OPN}		-55	-32	_	G
Release Point	B _{RPS}		6	26	_	G
Treicase i Oliit	B _{RPN}		_	-26	-6	G
Hysteresis	B _{HYS}	$B_{HYS} = B_{OPX} - B_{RPX}$	-	6	_	G

 $^{^{1}}$ Typical values at V_{DD} = 2.75 V. Performance may vary for individual units, within the specified maximum and minimum limits.



²Magnetic operate and release points vary with supply voltage.

 $^{^3}$ If SR < SR(min), then valid device output might be delayed for one Period, t_{PERIOD} , of device.

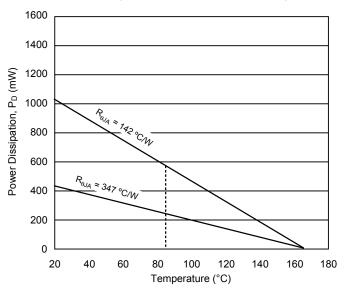
⁴1 gauss (G) is exactly equal to 0.1 millitesla (mT).

THERMAL CHARACTERISTICS may require derating at maximum conditions*

Characteristic	Symbol	Test Conditions	Value	Units
Package Thermal Resistance	D	On 1-layer PCB	347	°C/W
ackage memaricesistance	$R_{\theta JA}$	On 4-layer PCB	147	°C/W

^{*}Additional thermal information is available on the Allegro website.

Power Dissipation versus Ambient Temperature





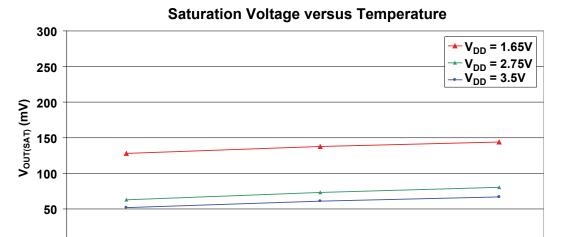
0

-60

-40

-20

Operating Characteristics



Saturation Voltage versus Supply Voltage

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T_A (°C)

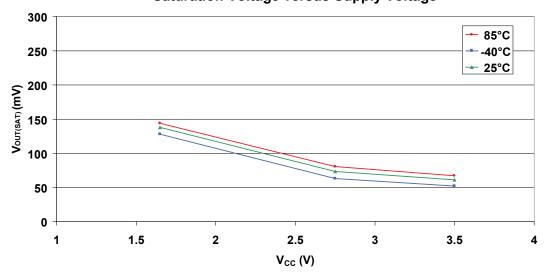
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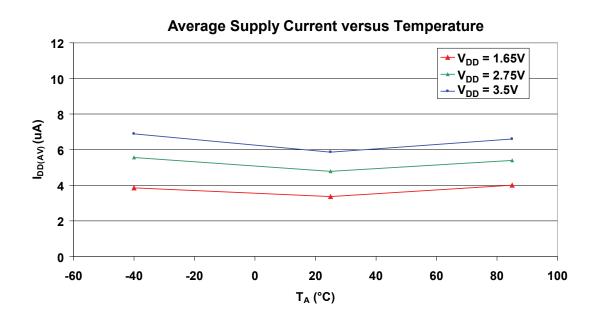
60

80

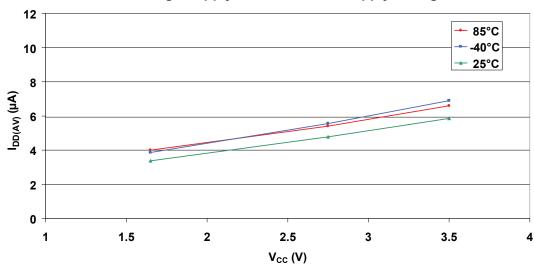
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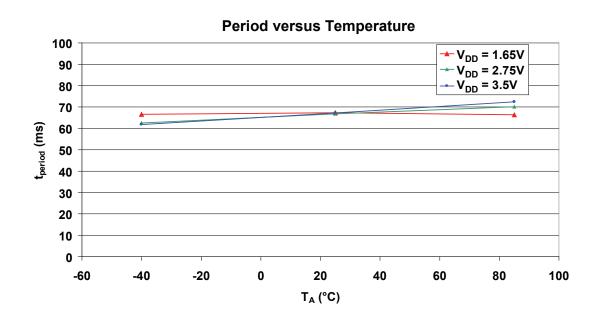
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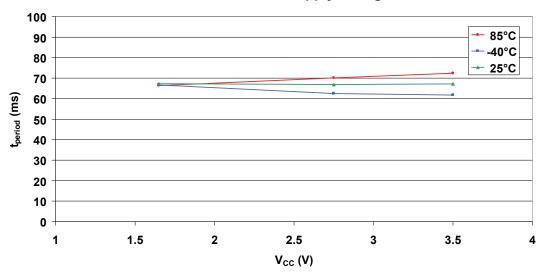


Average Supply Current versus Supply Voltage





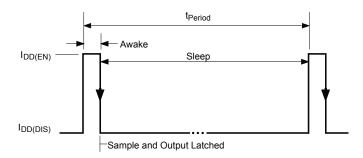
Period versus Supply Voltage



Functional Description

Low Average Power

Internal timing circuitry activates the IC for $50~\mu s$ and deactivates it for the remainder of the period (50~m s). A short awake time allows stabilization prior to the sampling and data-latching on the falling edge of the timing pulse. The output during the sleep state is latched in the last sampled state. The supply current is not affected by the output state.



Operation

The VOUTPS output switches low (turns on) when a magnetic field perpendicular to the Hall element exceeds the operate point,

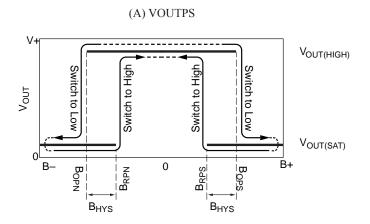
 B_{OPS} (or is less than B_{OPN}). After turn-on, the output voltage is $V_{OUT(SAT)}$. The output transistor is capable of sinking current up to the short circuit current limit, I_{OM} , which is a minimum of 1 mA. When the magnetic field is reduced below the release point, B_{RPS} (or increased above B_{RPN}), the device output switches high (turns off). The pull-up transistor brings the output voltage to $V_{OUT(HIGH)}$.

VOUTPN operates with the opposite output polarity. That is, the output is low (on) in the absence of a magnetic field. The output goes high (turns off) when sufficient field, of either north or south polarity, is presented to the device.

The difference in the magnetic operate and release points is the hysteresis, B_{HYS} , of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise.

The push-pull outputs are capable of sourcing or sinking a maximum of 1 mA.

Powering-on the device in a hysteresis region, between B_{OPX} and B_{RPX} , allows an indeterminate output state. The correct state is attained after the first excursion beyond B_{OPX} or B_{RPX} .



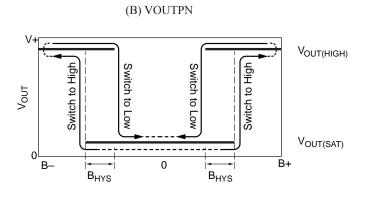


Figure 1. Switching Behavior of Omnipolar Switches. On the horizontal axis, the B+ direction indicates increasing south polarity magnetic field strength, and the B- direction indicates decreasing south polarity field strength (including the case of increasing north polarity).



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Applications

It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall element) between the supply and ground of the device to reduce both external noise and noise generated by the chopper stabilization technique. As is shown in figure 2, a $0.1~\mu F$ capacitor is typical.

Extensive applications information on magnets and Hall-effect devices is available in the following notes:

- Hall-Effect IC Applications Guide, AN27701
- Hall-Effect Devices: Gluing, Potting, Encapsulating, Lead Welding and Lead Forming AN27703.1
- Soldering Methods for Allegro Products (SMD and Through-Hole), AN26009

All are provided in Allegro Electronic Data Book, AMS-702, and on the Allegro Web site, www.allegromicro.com.

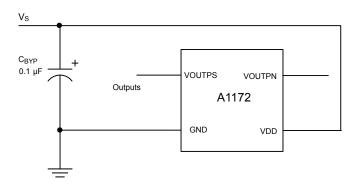
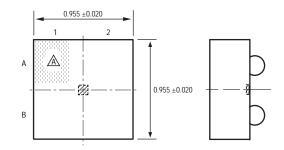
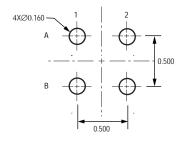
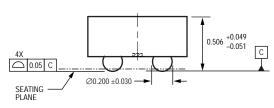


Figure 2. Typical Application Circuit

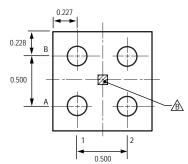
Package CG, 4-Bump WLCSP













Standard Branding Reference View

N = Last two digits of device part number Y = Last digit of year of manufacture W = Week of manufacture

For Reference Only, not for tooling use Dimensions in millimeters Exact configuration at supplier discretion within limits shown

A Terminal #A1 mark area (substrate side)

Hall element (not to scale)

Reference view of typical layout for solder pads
All pads a minimum of 0.20 mm from all adjacent pads;
adjust as necessary to meet application process
requirements and PCB layout tolerances

Branding scale and appearance at supplier discretion

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Revision History

Revision	Revision Date	Description of Revision
Rev. 5	October 26, 2011	Update Selection Guide

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